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# PNZ155 (PN155)

## Silicon planar type

For optical control systems

### ■ Features

- High sensitivity
- Wide spectral sensitivity characteristics, suited for detecting GaAs LEDs
- Low collector-emitter cutoff current (base open)
- Flat type plastic package

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-emitter voltage (Base open)	$V_{CEO}$	20	V
Emitter-collector voltage (Base open)	$V_{ECO}$	5	V
Collector current	$I_C$	10	mA
Collector power dissipation	$P_C$	100	mW
Operating ambient temperature	$T_{opr}$	-25 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-30 to +100	$^\circ\text{C}$

### ■ Electrical-Optical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Photocurrent *1	$I_L$	$V_{CE} = 10\text{ V}, L = 100\text{ lx}$	0.05	0.2		$\mu\text{A}$
Collector-emitter cutoff current (Base open)	$I_{CEO}$	$V_{CE} = 10\text{ V}$		0.01	1.0	$\mu\text{A}$
Collector-emitter saturation voltage *1	$V_{CE(sat)}$	$I_L = 1\text{ mA}, L = 1000\text{ lx}$		0.2	0.5	V
Peak emission wavelength	$\lambda_p$	$V_{CE} = 10\text{ V}$		800		nm
Half-power angle	$\theta$	The angle when the photocurrent is halved		70		$^\circ$
Rise time *2	$t_r$	$V_{CC} = 10\text{ V}, I_L = 1\text{ mA}, R_L = 100\ \Omega$		4		$\mu\text{s}$
Fall time *2	$t_f$			4		$\mu\text{s}$

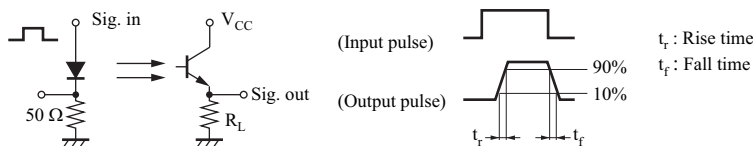
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. Spectral sensitivity characteristics: Sensitivity for wave length over 400 nm maximum sensitivity ratio is 100%.

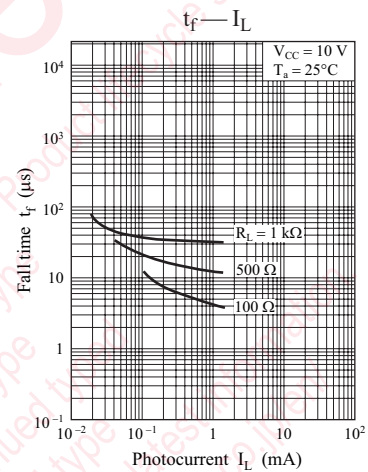
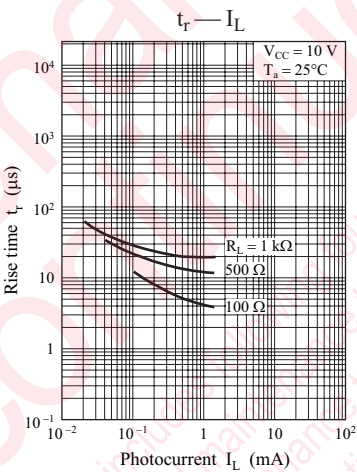
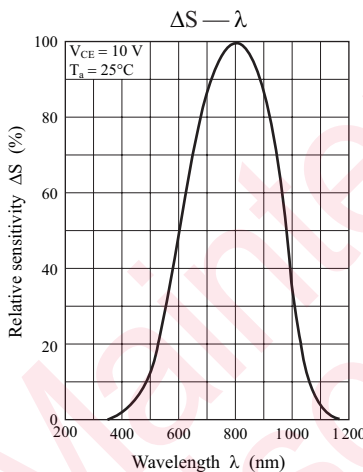
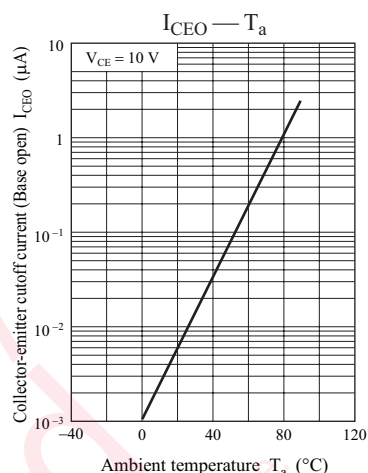
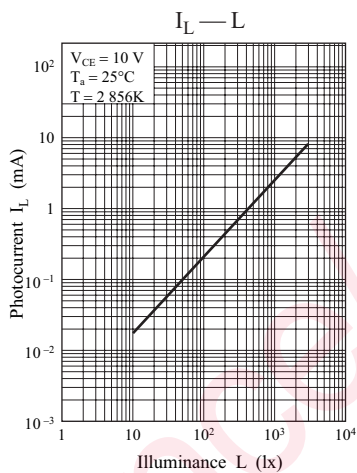
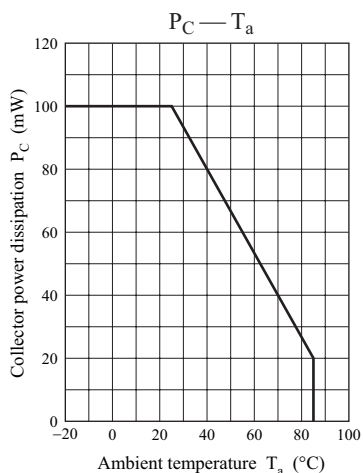
3. This device is designed by disregarding radiation.

4. \*1: Source: Tungsten lamp (color temperature 2856K)

\*2: Switching time measurement circuit

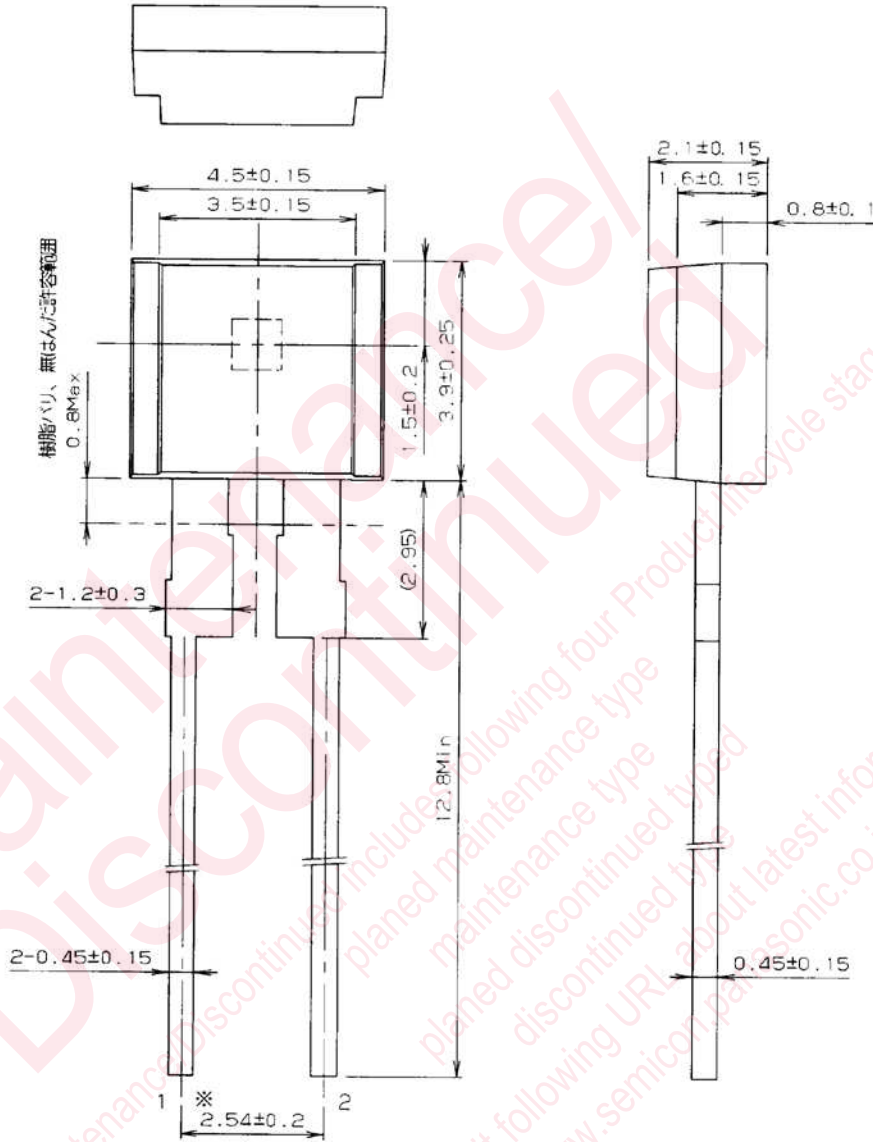


Note) The part number in the parenthesis shows conventional part number.



■ Package (Unit: mm)

LPTFSN2S0001



(注 1) ※リード根元寸法とする。  
 (Note 1) ※Indicates root dimensions of lead.

- Pin name
- 1: Emitter
- 2: Collector

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